

BGU7061Analog high linearity low noise variable gain amplifierRev. 1 - 21 January 2014Product data sheet

1. Product profile

1.1 General description

The BGU7061 is a fully integrated analog-controlled variable gain amplifier module. Its low noise and high linearity performance makes it ideal for sensitive receivers in cellular base station applications. The BGU7061 is operating in the 800 MHz to 915 MHz frequency range and has a gain control range of more than 35 dB. At maximum gain the noise figure is 0.74 dB. The gain is analog-controlled having maximum gain at 0 V and minimum gain at 3.3 V. The LNA can be bypassed extending the dynamic range. The BGU7061 is internally matched to 50 ohm, meaning no external matching is required, enabling ease of use. It is housed in a 16 pins 8 mm \times 8 mm \times 1.3 mm leadless HLQFN16R package SOT1301.

1.2 Features and benefits

- Input and output internally matched to 50 Ω
- Low noise figure of 0.74 dB
- High input IP3 of 2 dBm
- High P_{i(1dB)} of –12.5 dBm
- Bypass mode of LNA giving high dynamic gain range
- Gain control range of 0 dB to 35 dB
- Single 5 V supply
- Single analog gain control of 0 V to 3.3 V
- Unconditionally stable up to 12.75 GHz
- Moisture sensitivity level 3
- ESD protection at all pins

1.3 Applications

- Cellular base stations, remote radio heads
- 3G, LTE infrastructure
- Low noise applications with variable gain and high linearity requirements
- Active antenna



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1.4 Quick reference data

Table 1. Quick reference data

GS1 = LOW; GS2 = HIGH (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f = 900 N	1Hz					
I _{CC(tot)}	total supply current	high gain mode	<mark>11</mark> 197	229	267	mA
		low gain mode	2 175	199	230	mA
NF	noise figure	V _{ctrl(Gp)} = 0 V (maximum power gain)	<u>[1]</u> _	0.74	-	dB
		G _p = 35 dB	<u>[1]</u> _	0.87	1.05	dB
IP3 _I	input third-order intercept point	G_p = 35 dB; 2-tone; tone-spacing = 1.0 MHz	[<u>1]</u> 1	2.0	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression	G _p = 35 dB	<u>[1]</u> –13.5	-12.5	-	dBm
f = 830 N	ſHz					
I _{CC(tot)}	total supply current	high gain mode	<mark>11</mark> 197	229	267	mA
		low gain mode	2 175	199	230	mA
NF	noise figure	V _{ctrl(Gp)} = 0 V (maximum power gain)	<u>[1]</u> _	0.61	-	dB
		G _p = 35 dB	<u>[1]</u> _	0.75	1.05	dB
IP3 _I	input third-order intercept point	$G_p = 35 \text{ dB}$; 2-tone; tone-spacing = 1.0 MHz	[<u>1]</u> 1	2.7	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression	G _p = 35 dB	[<u>1]</u> –13.5	-12.4	-	dBm
f = 850 N	1Hz					
I _{CC(tot)}	total supply current	high gain mode	[<u>1]</u> 197	229	267	mA
		low gain mode	[2]	200	-	mA
NF	noise figure	V _{ctrl(Gp)} = 0 V (maximum power gain)	<u>[1]</u> _	0.64	-	dB
		G _p = 35 dB	<u>[1]</u> _	0.77	1.05	dB
IP3 _I	input third-order intercept point	$G_p = 35 \text{ dB}$; 2-tone; tone-spacing = 1.0 MHz	<u>[1]</u> 1	2.9	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression	G _p = 35 dB	<u>[1]</u> –13.5	-12.4	-	dBm

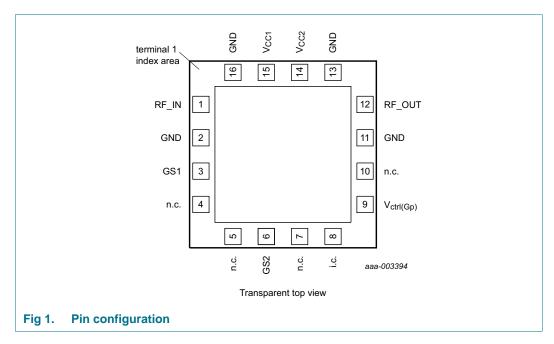
[1] high gain mode: GS1 = LOW; GS2 = HIGH (see Table 13)

[2] low gain mode: GS1 = HIGH; GS2 = LOW (see Table 13)

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2. Pinning information

2.1 Pinning



2.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
RF_IN	1	RF input
GND	2, 11, 13, 16	ground
GS1	3	gain switch control 1
n.c.	4, 5, 7, 10	not connected, internally open
GS2	6	gain switch control 2
i.c.	8	internally connected to ground
V _{ctrl(Gp)}	9	power gain control voltage
RF_OUT	12	RF output
V _{CC2}	14	supply voltage 2
V _{CC1}	15	supply voltage 1

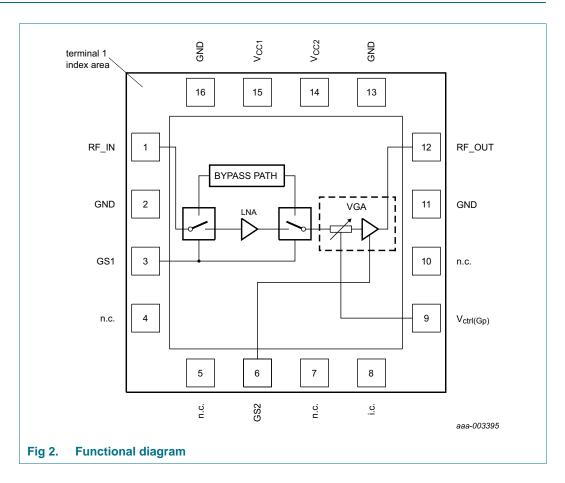
3. Ordering information

Gable 3. Ordering information					
Type number	Package				
	Name	Description	Version		
BGU7061	HLQFN16R	plastic thermal enhanced low quad flat package; no leads; 16 terminals; body $8 \times 8 \times 1.3$ mm	SOT1301-1		

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4. Functional diagram



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5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			0	6	V
				-	-	
V _{ctrl(Gp)}	power gain control voltage			-1	+3.6	V
V _{I(GS1)}	input voltage on pin GS1			–1	+3.6	V
V _{I(GS2)}	input voltage on pin GS2			-1	+3.6	V
P _{i(RF)CW}	continuous waveform RF input power	high gain mode; V _{ctrl(Gp)} = 0 V	[1]	-	10	dBm
		low gain mode; $V_{ctrl(Gp)} = 0 V$	[2]	-	15	dBm
Tj	junction temperature			-	150	°C
T _{stg}	storage temperature			-40	+150	°C
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM); according to ANSI/ESDA-JEDEC JS-001-2020-Device Testing, Human Body Model		-	±2	kV
		Charged Device Model (CDM); according to JEDEC standard 22-C101		-	±750	V

[1] high gain mode: GS1 = LOW; GS2 = HIGH (see Table 13)

[2] low gain mode: GS1 = HIGH; GS2 = LOW (see <u>Table 13</u>)

6. Recommended operating conditions

Table 5.	Recommended operating cond	litions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC1}	supply voltage 1		4.75	5	5.25	V
V _{CC2}	supply voltage 2		4.75	5	5.25	V
V _{ctrl(Gp)}	power gain control voltage		0	-	3.3	V
V _{I(GS1)}	input voltage on pin GS1		0	-	3.3	V
V _{I(GS2)}	input voltage on pin GS2		0	-	3.3	V
Z ₀	characteristic impedance		-	50	-	Ω
T _{case}	case temperature		-40	-	+85	°C

7. Thermal characteristics

Table 6.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-case)}	thermal resistance from junction to case		<u>[1]</u> 42	K/W

[1] The case temperature is measured at the ground solder pad.

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8. Characteristics

8.1 Characteristics at f = 900 MHz

Table 7. Characteristics high gain mode

GS1 = LOW; GS2 = HIGH (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 900 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC(tot)}	total supply current		197	229	267	mA
G _{p(min)}	minimum power gain	$V_{ctrl(Gp)} = 3.3 V$	-	12.7	-	dB
G _{p(max)}	maximum power gain	$V_{ctrl(Gp)} = 0 V$	-	36.7	-	dB
G _{p(flat)}	power gain flatness	880 MHz \leq f \leq 915 MHz; 18 dB \leq G_p \leq 35 dB	-	0.0	-	dB
NF	noise figure	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	0.74	-	dB
		G _p = 35 dB	-	0.87	1.05	dB
		G _p = 18 dB	-	6.47	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz				
		$G_p = 35 \text{ dB}$	1	2.0	-	dBm
		$G_p = 30 \text{ dB}$	-	4.8	-	dBm
		$G_p = 29 \text{ dB}$	-	5.0	-	dBm
		G _p = 18 dB	-	6.3	-	dBm
P _{i(1dB)}	input power at 1 dB	G _p = 35 dB	-13.5	-12.5	-	dBm
	gain compression	$G_p = 30 \text{ dB}$	-	-7.6	-	dBm
		$G_p = 29 \text{ dB}$	-	-6.8	-	dBm
		G _p = 18 dB	-	-4.8	-	dBm
RL _{in}	input return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	30.5	-	dB
		$G_p = 35 \text{ dB}$	-	28.0	-	dB
RL _{out}	output return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	17.5	-	dB
K	Rollett stability factor	0 GHz ≤ f ≤ 12.75 GHz	1	-	-	

Table 8. Characteristics low gain mode

GS1 = HIGH; GS2 = LOW (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 900 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC(tot)}	total supply current		175	199	230	mA
G _{p(min)}	minimum power gain	$V_{ctrl(Gp)} = 3.3 V$	-	-5.9	-	dB
G _{p(max)}	maximum power gain	V _{ctrl(Gp)} = 0 V	-	18.3	-	dB
G _{p(flat)}	power gain flatness	880 MHz \leq f \leq 915 MHz; 3 dB \leq G_p \leq 17 dB	-	0.0	-	dB
NF	noise figure	G _p = 17 dB	-	11.2	-	dB
		G _p = 3 dB	-	22.9	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz			-	
		G _p = 17 dB	-	21.4	-	dBm
		G _p = 12 dB	-	26.5	-	dBm
		G _p = 11 dB	-	27.4	-	dBm
		G _p = 3 dB	-	31.2	-	dBm

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Table 8. Characteristics low gain mode ...continued

GS1 = HIGH; GS2 = LOW (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 900 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P _{i(1dB)}	input power at 1 dB gain compression	G _p = 17 dB	-	5.6	-	dBm
		G _p = 12 dB	-	10.4	-	dBm
		G _p = 11 dB	-	11.1	-	dBm
		G _p = 3 dB	-	13.2	-	dBm
RL _{in}	input return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	25.1	-	dB
		G _p = 17 dB	-	22.7	-	dB
RL _{out}	output return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	18.3	-	dB
К	Rollett stability factor	$0 \text{ GHz} \leq f \leq 12.75 \text{ GHz}$	1	-	-	

8.2 Characteristics at f = 830 MHz

Table 9. Characteristics high gain mode

GS1 = LOW; GS2 = HIGH (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 830 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC(tot)}	total supply current		197	229	267	mA
G _{p(min)}	minimum power gain	V _{ctrl(Gp)} = 3.3 V	-	12.7	-	dB
G _{p(max)}	maximum power gain	V _{ctrl(Gp)} = 0 V	-	36.8	-	dB
G _{p(flat)}	power gain flatness	815 MHz \leq f \leq 840 MHz; 18 dB \leq G_p \leq 35 dB	-	0.1	-	dB
NF	noise figure	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	0.61	-	dB
		$G_p = 35 \text{ dB}$	-	0.75	1.05	dB
		$G_p = 18 \text{ dB}$	-	5.49	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz				
		$G_p = 35 \text{ dB}$	1	2.7	-	dBm
		$G_p = 30 \text{ dB}$	-	4.8	-	dBm
		$G_p = 29 \text{ dB}$	-	5.1	-	dBm
		$G_p = 18 \text{ dB}$	-	6.4	-	dBm
P _{i(1dB)}	input power at 1 dB	G _p = 35 dB	-13.5	-12.4	-	dBm
	gain compression	$G_p = 30 \text{ dB}$	-	-7.6	-	dBm
		$G_p = 29 \text{ dB}$	-	-6.9	-	dBm
		$G_p = 18 \text{ dB}$	-	-4.8	-	dBm
RL _{in}	input return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	24.0	-	dB
		$G_p = 35 \text{ dB}$	-	24.8	-	dB
RL _{out}	output return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	18.0	-	dB
К	Rollett stability factor	$0 \text{ GHz} \leq f \leq 12.75 \text{ GHz}$	1	-	-	

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Table 10. Characteristics low gain mode

GS1 = HIGH; GS2 = LOW (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 830 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC(tot)}	total supply current		175	199	230	mA
G _{p(min)}	minimum power gain	V _{ctrl(Gp)} = 3.3 V	-	-6.1	-	dB
G _{p(max)}	maximum power gain	V _{ctrl(Gp)} = 0 V	-	18.4	-	dB
G _{p(flat)}	power gain flatness	815 MHz \leq f \leq 840 MHz; 3 dB \leq G_p \leq 17 dB	-	0.0	-	dB
NF	noise figure	G _p = 17 dB	-	10.4	-	dB
		$G_p = 3 dB$	-	22.0	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz			-	
		$G_p = 17 \text{ dB}$	-	21.7	-	dBm
		$G_p = 12 \text{ dB}$	-	26.9	-	dBm
		$G_p = 11 \text{ dB}$	-	27.7	-	dBm
		$G_p = 3 dB$	-	31.4	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression	G _p = 17 dB	-	5.8	-	dBm
		$G_p = 12 \text{ dB}$	-	10.5	-	dBm
		G _p = 11 dB	-	11.9	-	dBm
		$G_p = 3 dB$	-	13.6	-	dBm
RL _{in}	input return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	25.5	-	dB
		$G_p = 17 \text{ dB}$	-	24.0	-	dB
RL _{out}	output return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	19.4	-	dB
К	Rollett stability factor	$0 \text{ GHz} \le f \le 12.75 \text{ GHz}$	1	-	-	

8.3 Characteristics at f = 850 MHz

Table 11. Characteristics high gain mode

GS1 = LOW; GS2 = HIGH (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 850 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC(tot)}	total supply current		197	229	267	mA
G _{p(min)}	minimum power gain	V _{ctrl(Gp)} = 3.3 V	-	12.7	-	dB
G _{p(max)}	maximum power gain	$V_{ctrl(Gp)} = 0 V$	-	36.7	-	dB
G _{p(flat)}	power gain flatness	825 MHz \leq f \leq 865 MHz; 18 dB \leq G_{p} \leq 35 dB	-	0.1	-	dB
NF	noise figure	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	0.64	-	dB
		G _p = 35 dB	-	0.77	1.05	dB
		G _p = 18 dB	-	5.54	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz				
		G _p = 35 dB	1	2.9	-	dBm
		$G_p = 30 \text{ dB}$	-	4.8	-	dBm
		G _p = 29 dB	-	5.0	-	dBm
		G _p = 18 dB	-	6.4	-	dBm

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Table 11. Characteristics high gain mode ...continued

GS1 = LOW; GS2 = HIGH (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 850 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

				•		
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P _{i(1dB)}	input power at 1 dB gain compression	$G_p = 35 \text{ dB}$	-13.5	-12.4	-	dBm
		$G_p = 30 \text{ dB}$	-	-7.6	-	dBm
		$G_p = 29 \text{ dB}$	-	-6.9	-	dBm
		$G_p = 18 \text{ dB}$	-	-5.1	-	dBm
RL _{in}	input return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	25.1	-	dB
		$G_p = 35 \text{ dB}$	-	26.5	-	dB
RL _{out}	output return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	17.5	-	dB
К	Rollett stability factor	$0 \text{ GHz} \le f \le 12.75 \text{ GHz}$	1	-	-	

Table 12. Characteristics low gain mode

GS1 = HIGH; GS2 = LOW (see <u>Table 13</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 850 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I _{CC(tot)}	total supply current		-	200	-	mA
G _{p(min)}	minimum power gain	V _{ctrl(Gp)} = 3.3 V	-	-6.0	-	dB
G _{p(max)}	maximum power gain	V _{ctrl(Gp)} = 0 V	-	18.3	-	dB
G _{p(flat)}	power gain flatness	825 MHz $\leq f \leq$ 865 MHz; 3 dB $\leq G_p \leq$ 17 dB	-	0.0	-	dB
NF	noise figure	$G_p = 17 \text{ dB}$	-	10.4	-	dB
		$G_p = 3 dB$	-	22.1	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz			-	
		$G_p = 17 \text{ dB}$	-	21.6	-	dBm
		$G_p = 12 \text{ dB}$	-	26.5	-	dBm
		$G_p = 11 \text{ dB}$	-	27.5	-	dBm
		$G_p = 3 dB$	-	31.4	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression	$G_p = 17 \text{ dB}$	-	5.7	-	dBm
		$G_p = 12 \text{ dB}$	-	10.5	-	dBm
		G _p = 11 dB	-	11.2	-	dBm
		$G_p = 3 dB$	-	13.5	-	dBm
RL _{in}	input return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	25.1	-	dB
		G _p = 17 dB	-	23.5	-	dB
RL _{out}	output return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	18.7	-	dB
К	Rollett stability factor	$0 \text{ GHz} \leq f \leq 12.75 \text{ GHz}$	1	-	-	

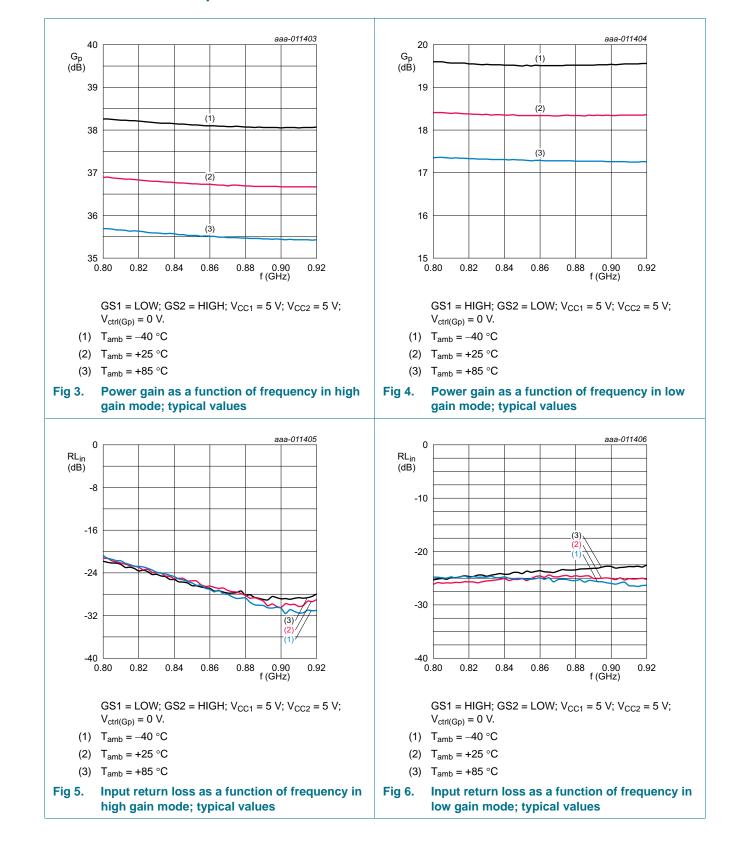
8.4 Gain switch truth table

Table 13. Gain switch truth table

 $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; $T_{amb} = 25 °C$

Gain mode	GS1	GS1		
	logic	V _{GS1}	logic	V _{GS2}
high gain mode	LOW	0 V to 0.5 V	HIGH	2 V to 3.3 V
low gain mode	HIGH	2 V to 3.3 V	LOW	0 V to 0.5 V

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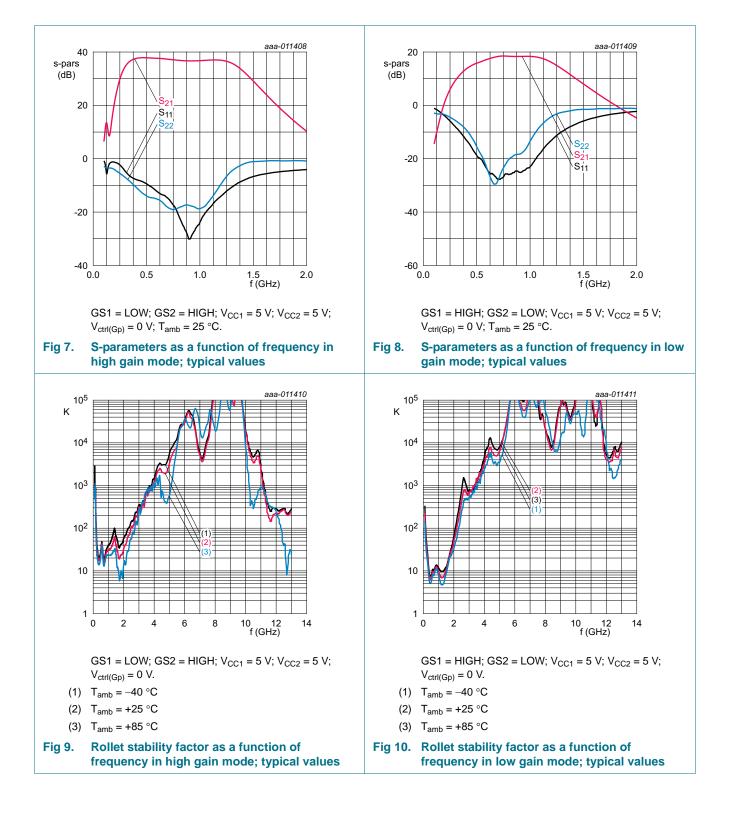


8.5 Graphs

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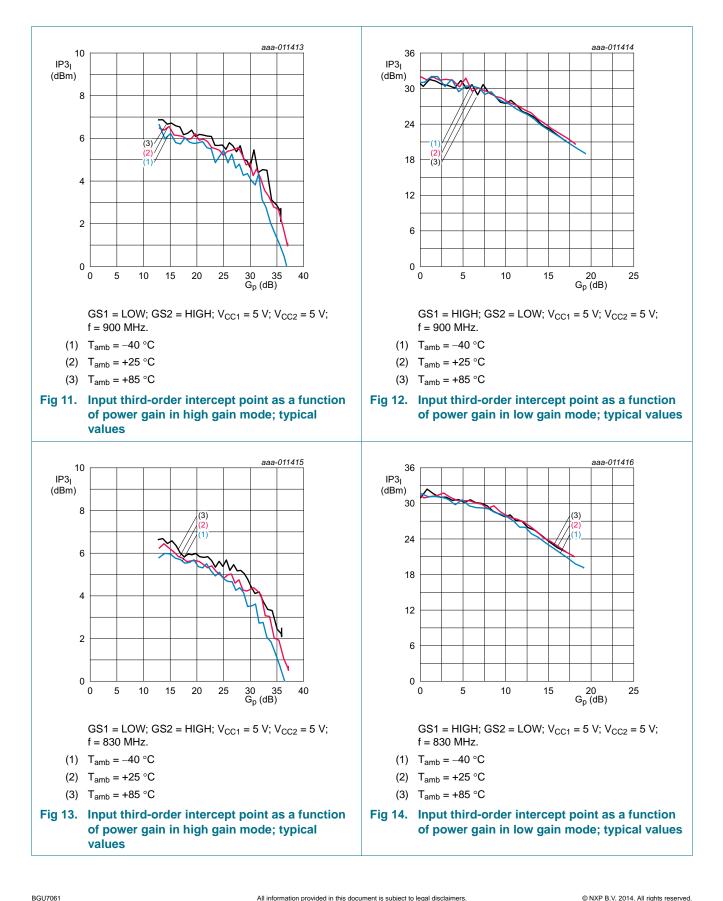


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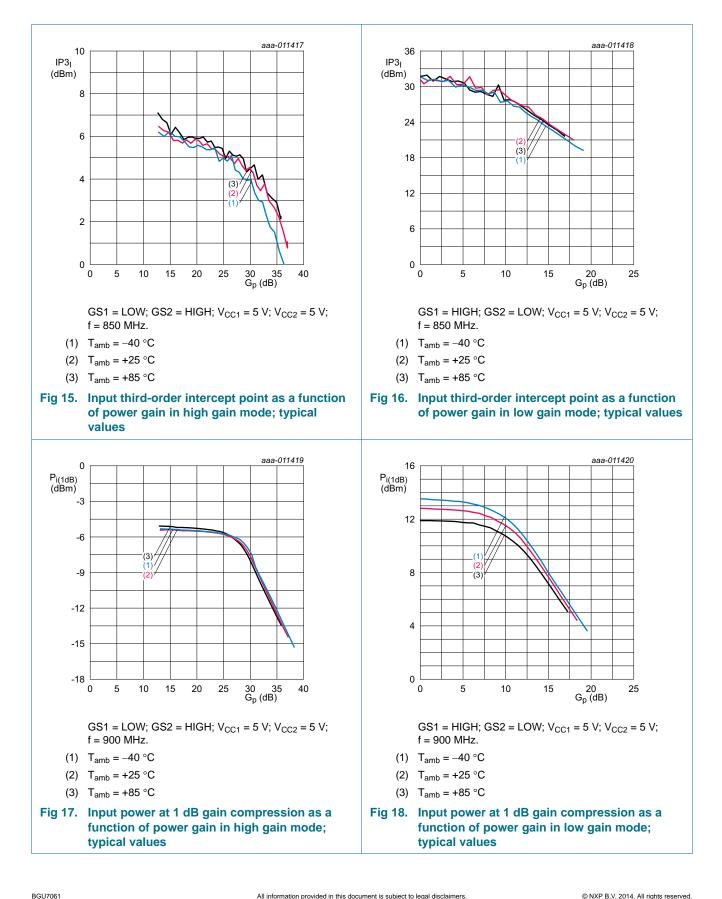
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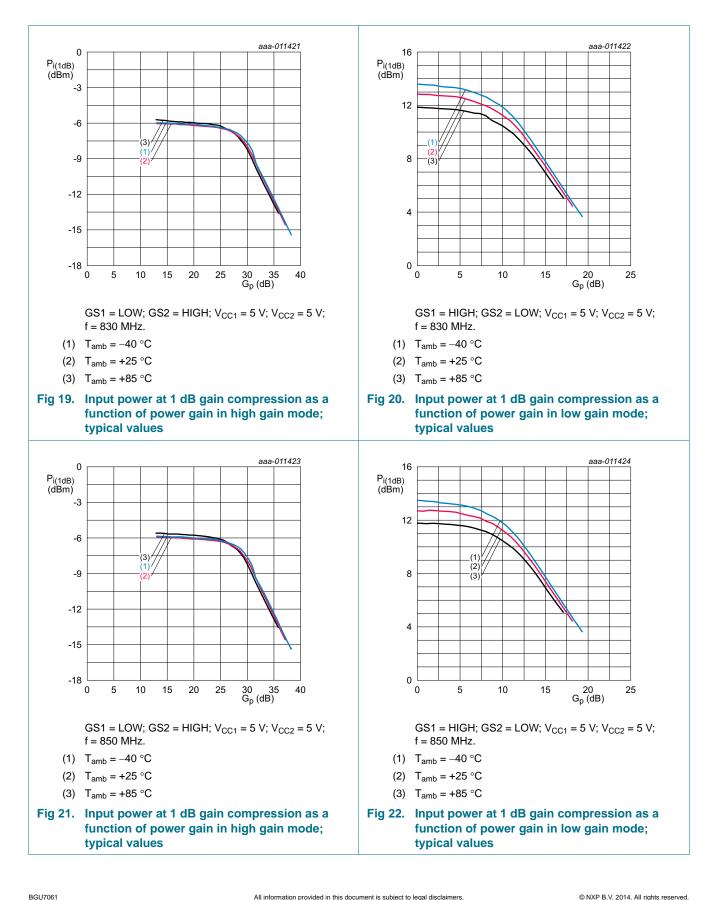
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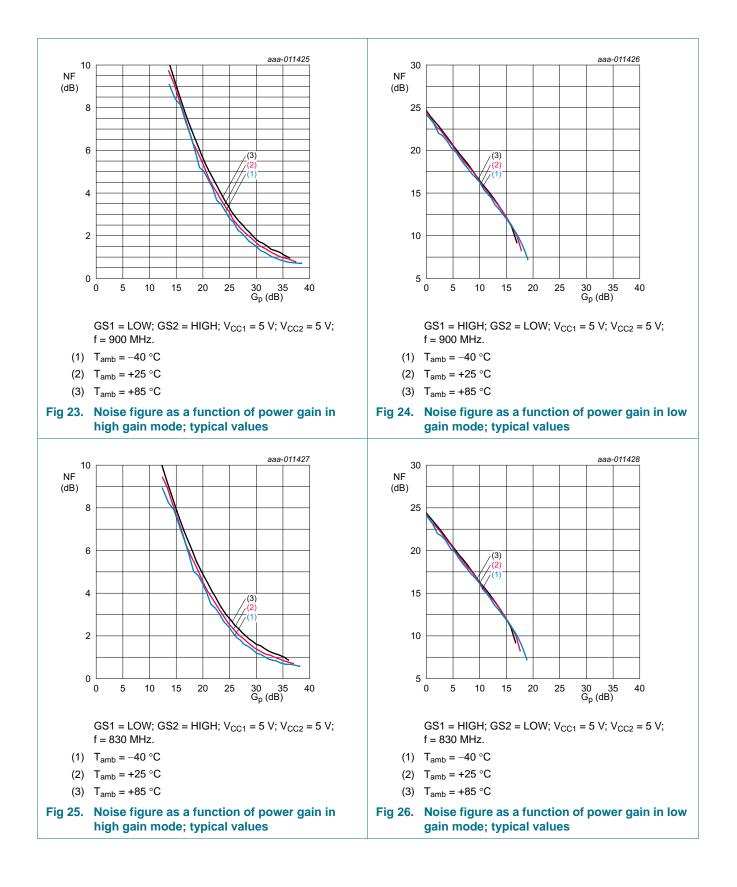
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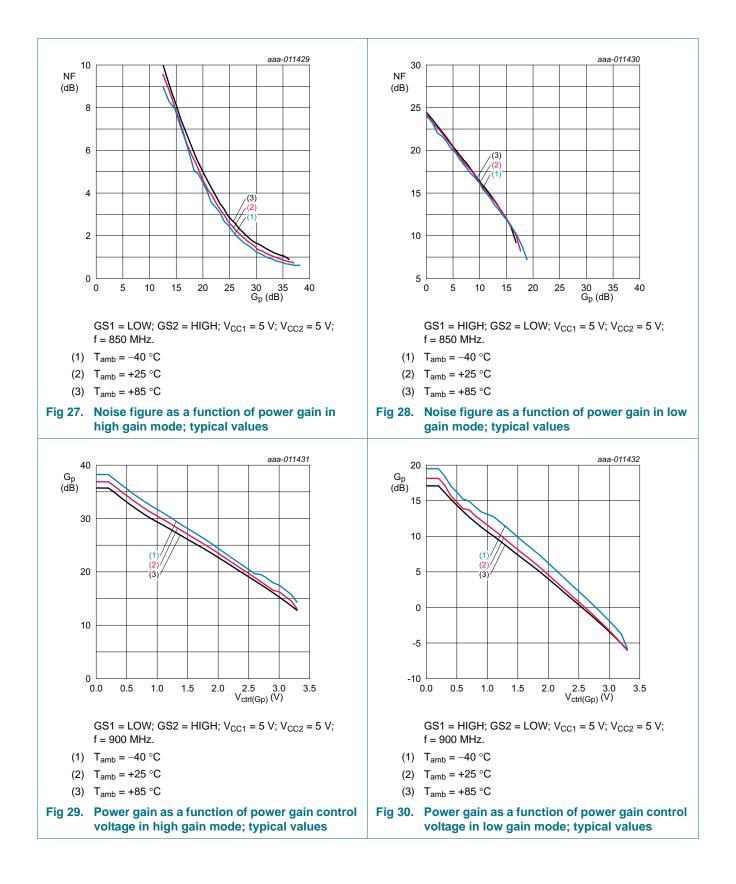
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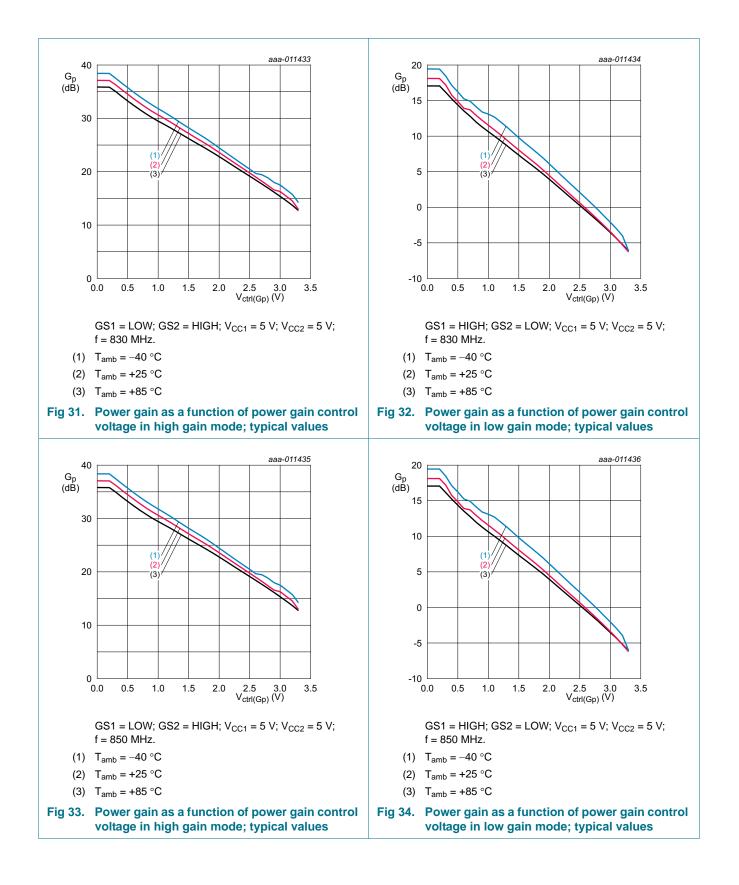
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Application information 9.

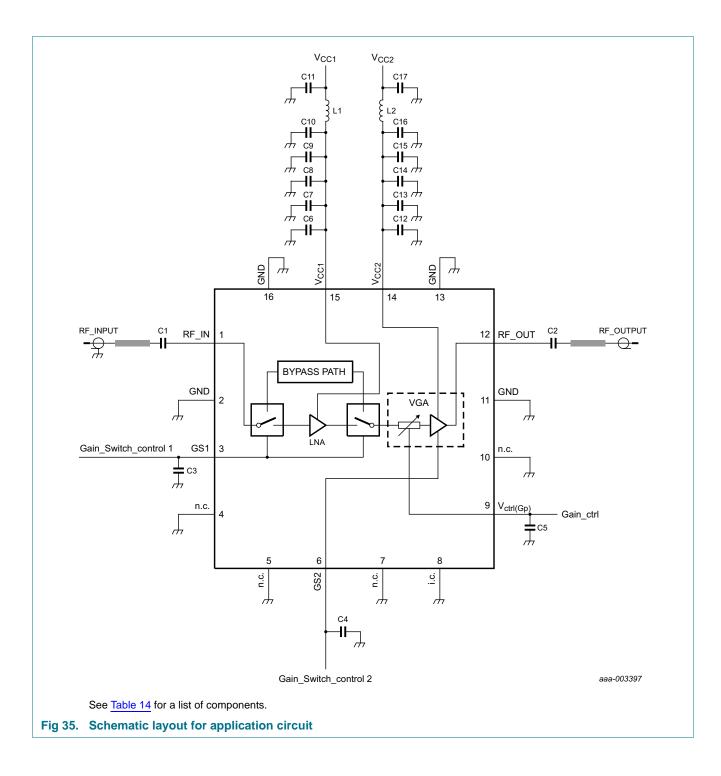
Table 14. List of components For application circuit see Figure 35.					
Component	Description	Value		Remarks	
C1, C2	capacitor	1 nF	[1]	0402	
C3, C4, C5, C6, C12	capacitor	100 pF	[1]	0402	
C7, C8, C9, C10,	capacitor	optional			
C11, C17	capacitor	100 nF	[1]	0402	
C13, C14, C15, C16	capacitor	optional			
L1, L2	inductor	10 nH	[2]	0402	

[1] Murata GRM1555 series.

[2] Murata LQG15 series.

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10. Package outline

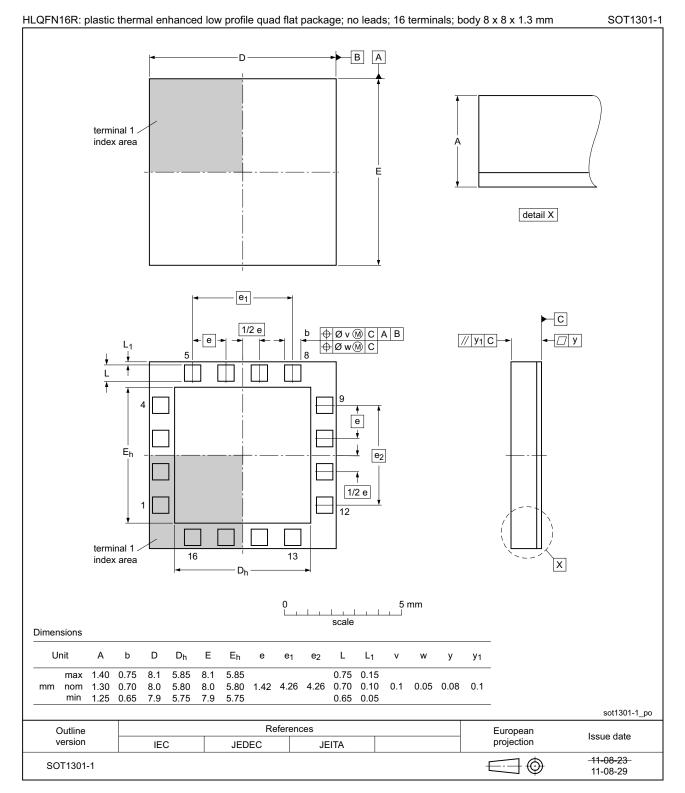


Fig 36. Package outline SOT1301-1 (HLQFN16R)

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11. Abbreviations

Table 15. Abbreviations				
Acronym	Description			
3G	3rd Generation			
ESD	ElectroStatic Discharge			
LNA	Low Noise Amplifier			
LTE	Long Term Evolution			

12. Revision history

Table 16.	Revision	history
		motory

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGU7061 v.1	20140121	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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